

PS2514-1, PS2514L-1

R08DS0012EJ0200 Rev.2.00 Oct. 27, 2023

HIGH-SPEED SWITCHING/HIGH ISOLATION VOLTAGE PHOTOCOUPLER SERIES

DESCRIPTION

The PS2514-1 and PS2514L-1 are optically coupled isolator containing a GaAs light emitting diode and an NPN silicon phototransistor, enabling relatively high switching speed with high load resistor of several $k\Omega$. The PS2514-1 is in a plastic DIP (Dual In-line Package) and the PS2514L-1 is lead bending type (Gull-wing) for surface mount.

FEATURES

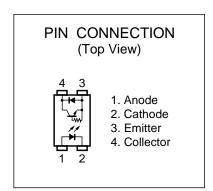
- High isolation voltage (BV = 5 000 Vr.m.s.)
- High collector to emitter voltage (V_{CEO} = 40 V)
- Guaranteed maximum switching speed

(toff
$$\leq$$
 25 μ s @ I_F = 5 mA, V_{CC} = 5 V, R_L = 5 k Ω)

- High-speed switching
- (ton = 15 μ s TYP. @ I_F = 5 mA, V_{CC} = 5 V, R_L = 5 k Ω)
- (toff = 15 μ s TYP. @ I_F = 5 mA, V_{CC} = 5 V, R_L = 5 k Ω)
- Embossed tape product: PS2514L-1-F3: 2 000 pcs/reel
- Pb-free product
- Safety standards
 - UL approved: UL1577, Double protection
 - CSA approved: CAN/CSA-C22.2 No. 62368-1, Basic insulation, Reinforced insulation
 - CQC approved: GB4943.1, Basic insulation
 - VDE approved: DIN EN IEC 60747-5-5 (Option)

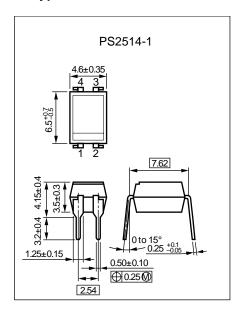
APPLICATIONS

- Power supply
- FA equipment
- Electronic electricity meter

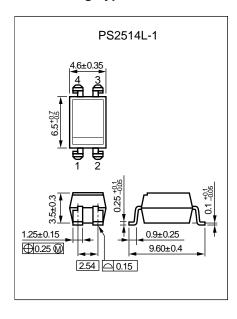


PACKAGE DIMENSIONS (UNIT: mm)

DIP Type



Lead Bending Type For Surface Mount

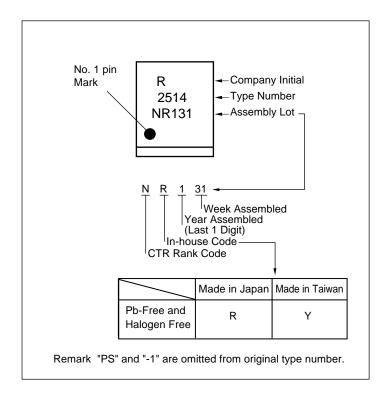


Weight (4-pin DIP) : 0.26 g (TYP.)

PHOTOCOUPLER CONSTRUCTION

Parameter	PS2514-1, PS2514L-1
Air Distance (MIN.)	7 mm
Creepage Distance (MIN.)	7 mm
Isolation Distance (MIN.)	0.4 mm

MARKING EXAMPLE



ORDERING INFORMATION

Part Number	Order Number	Solder Plating Specification	Packing Style	Safety Standard Approval	Application Part Number *2	
PS2514-1	PS2514-1Y-A	Pb-Free and	Magazine case 100 pcs	Standard Products	PS2514-1	
PS2514L-1	PS2514L-1Y-A	Halogen Free		(UL, CSA, CQC - Approved)	PS2514L-1	
PS2514L-1-F3	PS2514L-1Y-F3-A		Embossed Tape 2 000 pcs/reel		PS2514L-1	
PS2514-1-V	PS2514-1Y-V-A		Magazine case 100 pcs	UL, CSA, CQC,	PS2514-1	
PS2514L-1-V	PS2514L-1Y-V-A				VDE Approved	PS2514L-1
PS2514L-1-V-F3	PS2514L-1Y-V-F3-A		Embossed Tape 2 000 pcs/reel		PS2514L-1	

Notes: *1. For the application of the safety standard, the following part number should be used.

ABSOLUTE MAXIMUM RATINGS (T_A = 25 °C, unless otherwise specified)

Parameter		Symbol	Ratings	Unit	
Diode	Reverse Voltage	V_R	6	V	
	Forward Current (DC)	lF	30	mA	
	Power Dissipation Derating	ΔP _D /°C	1.5	mW/°C	
	Power Dissipation	P _D	150	mW	
	Peak Forward Current *1	I _{FP}	0.5	А	
Transistor	Collector to Emitter Voltage	Vceo	40	V	
	Emitter to Collector Voltage	V _{ECO}	0.6	V	
	Collector Current		20	mA	
	Power Dissipation Derating	ΔPc/°C	1.5	mW/°C	
	Power Dissipation	Pc	150	mW	
Isolation Voltage *2		BV	5 000	Vr.m.s.	
Operating Ambient Temperature		T _A	-55 to +100	°C	
Storage Temperature		T _{stg}	-55 to +150	°C	

Note: *1. PW = 100 μ s, Duty Cycle = 1 %

RECOMMENDED OPERATING CONDITIONS

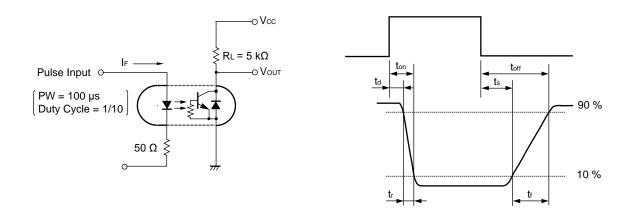
Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Input Current	l _F	5	6	7	mA

^{*2.} AC voltage for 1 minute at T_A = 25 °C, RH = 60 % between input and output. Pins 1-2 shorted together, 3-4 shorted together.

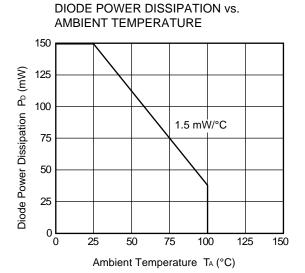
ELECTRICAL CHARACTERISTICS ($T_A = 25$ °C)

	Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Diode	Forward Voltage	VF	IF = 5 mA		1.1	1.3	V
	Reverse Current	lR	V _R = 5 V			5	μΑ
	Terminal Capacitance	Ct	V = 0 V, f = 1.0 MHz		10		pF
Transistor	Collector to Emitter Dark Current	Iceo	Vce = 40 V, IF = 0 mA			100	nA
Coupled	Current Transfer Ratio (Ic/IF)	CTR	IF = 5 mA, VcE = 5 V	50	125	200	%
	Collector Saturation Voltage	VCE (sat)	IF = 5 mA, Ic = 1 mA			0.35	V
	Isolation Resistance	Rı-o	Vi-o = 1.0 kVpc	10 ¹¹			Ω
	Isolation Capacitance	C _{I-O}	V = 0 V, f = 1.0 MHz		0.5		pF
	Turn-on Time *1	ton	$Vcc = 5 \text{ V}, \text{ IF} = 5 \text{ mA}, \text{ RL} = 5 \text{ k}\Omega$		15	25	μs
	Turn-off Time *1	t off			15	25	

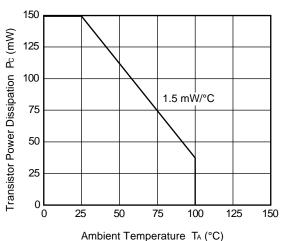
Note: *1. Test Circuit for Switching Time



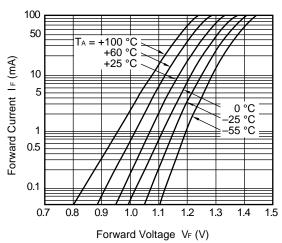
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise specified)



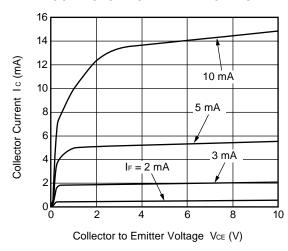
TRANSISTOR POWER DISSIPATION vs. AMBIENT TEMPERATURE



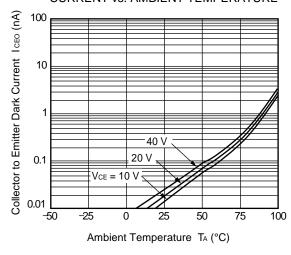
FORWARD CURRENT vs. FORWARD VOLTAGE



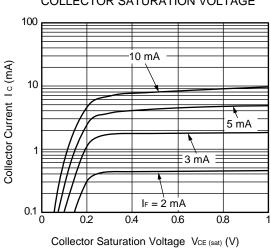
COLLECTOR CURRENT vs.
COLLECTOR TO EMITTER VOLTAGE



COLLECTOR TO EMITTER DARK CURRENT vs. AMBIENT TEMPERATURE

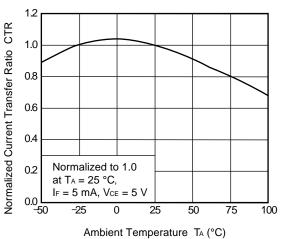


COLLECTOR CURRENT vs.
COLLECTOR SATURATION VOLTAGE

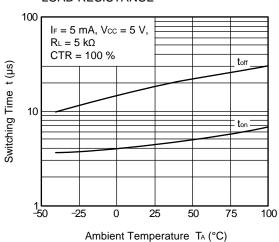


Remark The graphs indicate nominal characteristics.

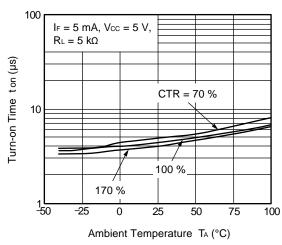
NORMALIZED CURRENT TRANSFER RATIO vs. AMBIENT TEMPERATURE



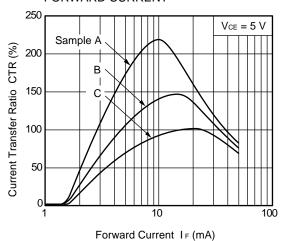
SWITCHING TIME vs. LOAD RESISTANCE



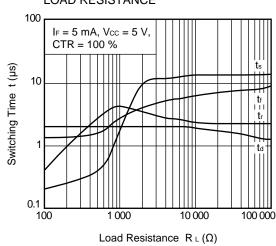
TURN-ON TIME vs. AMBIENT TEMPERATURE



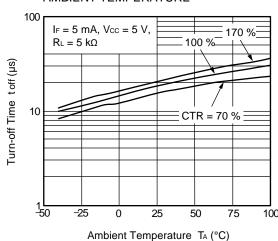
CURRENT TRANSFER RATIO vs. FORWARD CURRENT



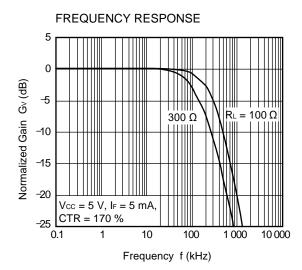
SWITCHING TIME vs. LOAD RESISTANCE



TURN-OFF TIME vs. AMBIENT TEMPERATURE

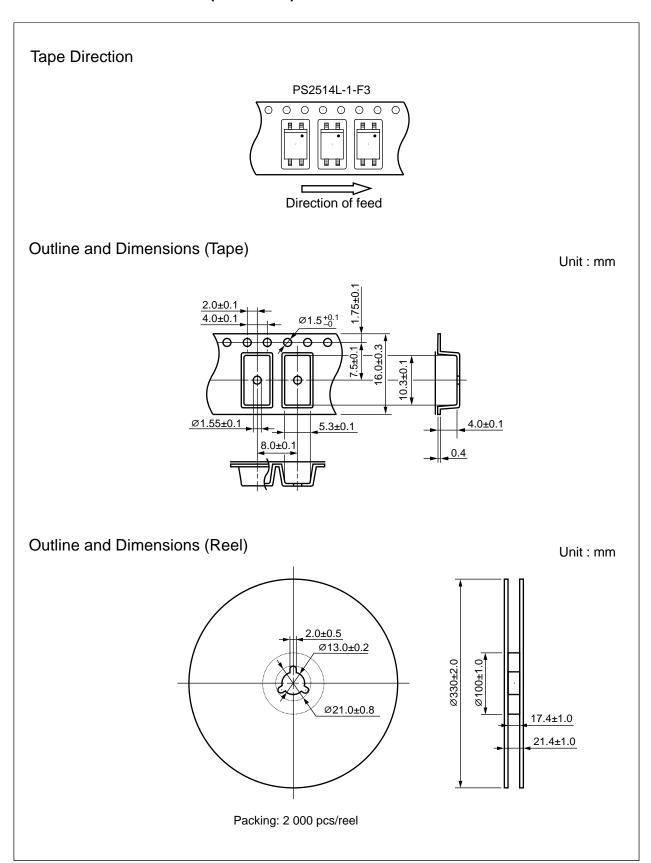


Remark The graphs indicate nominal characteristics.

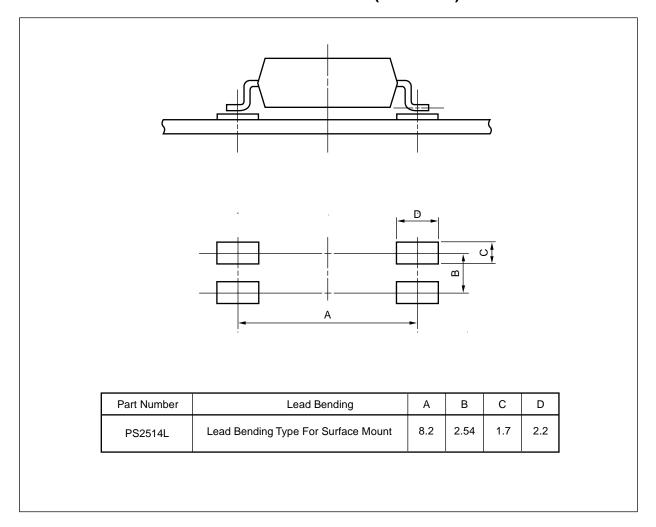


Remark The graphs indicate nominal characteristics.

TAPING SPECIFICATIONS (UNIT: mm)



RECOMMENDED MOUNT PAD DIMENSIONS (UNIT: mm)



Remark All dimensions in this figure must be evaluated before use.

NOTES ON HANDLING

- 1. Recommended soldering conditions
 - (1) Infrared reflow soldering

Peak reflow temperature
 260 °C or below (package surface temperature)

Time of peak reflow temperature
 Time of temperature higher than 220°C
 10 seconds or less
 60 seconds or less

• Time to preheat temperature from 120 to 180°C $\,$ 120 \pm 30 s

Number of reflows

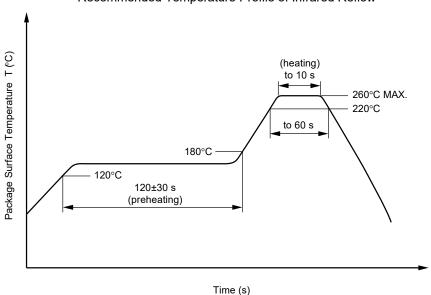
• Flux

Three

Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of

0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



(2) Wave soldering

• Temperature 260 °C or below (molten solder temperature)

Time 10 seconds or less

• Preheating conditions 120 °C or below (package surface temperature)

Number of times One (Allowed to be dipped in solder including plastic mold portion.)
 Flux Rosin flux containing small amount of chlorine (The flux with a maximum

chlorine content of 0.2 Wt% is recommended.)

(3) Soldering by Soldering Iron

Peak temperature (lead part temperature)
 Time (per one side)
 350 °C or below
 3 s or less

• Flux Rosin flux containing small amount of chlorine

(The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

• Place 1.5 to 2.0 mm or more away from the root of the lead

(4) Cautions

Flux cleaning
 Avoid cleaning with Freon- or halogen-based (chlorinated etc.) solvents.
 Fixing/Coating
 Do not use fixing agents or coatings containing halogen-based substances

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- 2. Cautions regarding noise
 - Be aware that when voltage is applied suddenly between the photocoupler's input and output or between collector-emitters at startup, the output transistor may enter the on state, even if the voltage is within the absolute maximum ratings.
- 3. Measurement conditions of current transfer ratios (CTR), which differ according to photocoupler Check the setting values before use, since the forward current conditions at CTR measurement differ according to product.
 - When using products other than at the specified forward current, the characteristics curves may differ from the standard curves due to CTR value variations or the like. Therefore, check the characteristics under the actual operating conditions and thoroughly take variations or the like into consideration before use.

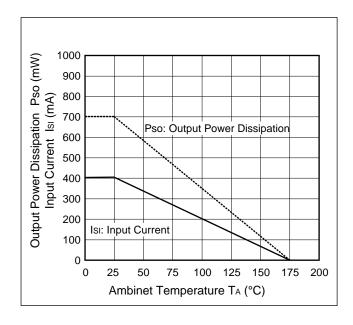
USAGE CAUTIONS

- 1. Protect against static electricity when handling.
- 2. Avoid storage at a high temperature and high humidity.
- 3. Avoid cleaning with Freon based or halogen-based (chlorinated etc.) solvents.
- 4. Do not use fixing agents or coatings containing halogen-based substances.

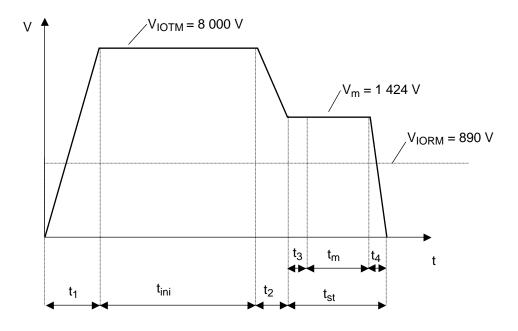
SPECIFICATION OF VDE MARKS LICENSE DOCUMENT

Parameter	Symbol	Rating	Unit
Climatic test class (IEC 60068-1/DIN EN 60068-1)		55/100/21	
Dielectric strength			
maximum operating isolation voltage	Viorm	890	V_{peak}
Test voltage (partial discharge test, procedure a for type test and random test)	Vm	1 424	V_{peak}
$V_m = 1.6 \times V_{IORM.}, q_{pd} < 5 pC$			
Test voltage (partial discharge test, procedure b for all devices)	V _m	1 669	V_{peak}
$V_m = 1.875 \times V_{IORM.}, q_{pd} < 5 pC$	v m	1 009	v peak
Highest permissible overvoltage	V_{IOTM}	8 000	V_{peak}
Degree of pollution (IEC 60664-1/DIN EN 60664-1 (VDE 0110-1))		2	
Comparative tracking index (IEC 60112/DIN EN 60112 (VDE 0303-11))	CTI	175	
Material group (IEC 60664-1/DIN EN 60664-1 (VDE 0110-1))		III a	
Storage temperature range	T _{stg}	-55 to +150	°C
Operating temperature range	T _A	-55 to +100	ô
Isolation resistance, minimum value			
V _{I-O} = 500 V dc, T _A = 25 °C	R _{I-O} MIN.	10 ¹²	Ω
V _{I-O} = 500 V dc, T _A = maximum temperature of rating, at least 100 °C	R _{I-O} MIN.	10 ¹¹	Ω
Safety maximum ratings (maximum permissible in case of fault, see thermal			
derating curve)			
Maximum ambient temperature	Ts	175	°C
Maximum input current	Isı	400	mA
Maximum output power dissipation	Pso	700	mW
Isolation resistance, minimum value at V _{I-O} = 500 V dc, T _A = T _S	R _{I-O} MIN.	10 ⁹	Ω

Dependence of maximum safety ratings with package temperature



Method a) Destructive Test, Type and Sample Test



 $t_1, t_2 = 1 \text{ to } 10 \text{ sec}$

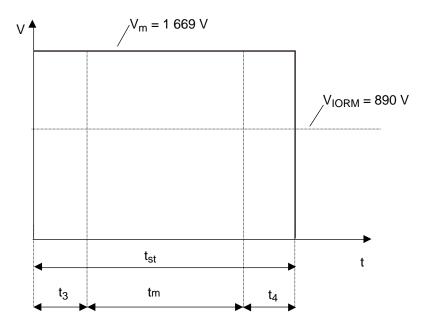
 $t_3, t_4 = 1 \text{ sec}$

 $t_m = 10 \text{ sec}$

 $t_{st} = 12 sec$

 $t_{ini} = 60 \text{ sec}$

Method b) Non-destructive Test, 100 % Production Test



 $t_3, t_4 = 0.1 \text{ sec}$

 $t_{\rm m} = 1.0 {\rm sec}$

 $t_{st} = 1.2 \text{ sec}$

Caution

GaAs Products

This product uses gallium arsenide (GaAs).

GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.

- Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
 - Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
- 2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
- Do not burn, destroy, cut, crush, or chemically dissolve the product.
- Do not lick the product or i any way allow it to enter the mouth.

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